WeEn Semiconductors

## 1. General description

Planar passivated Silicon Controlled Rectifier with sensitive gate in a SOT54 (TO-92) plastic package. This SCR is designed to be interfaced directly to microcontrollers, logic ICs and other low power gate trigger circuits.

## 2. Features and benefits

- Planar passivated for voltage ruggedness and reliability
- Sensitive gate
- Direct triggering from low power gate circuits and logic ICs


## 3. Applications

- Ignition circuits
- Lighting ballasts
- Protection circuits
- Switched Mode Power Supplies


## 4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {RRM }}$ | repetitive peak reverse voltage |  | - | - | 200 | V |
| $\mathrm{I}_{\text {(AV) }}$ | average on-state current | half sine wave; $\mathrm{T}_{\text {lead }} \leq 83^{\circ} \mathrm{C}$; Fig. 1 | - | - | 0.5 | A |
| $\mathrm{I}_{\text {(RMS) }}$ | RMS on-state current | half sine wave; $\mathrm{T}_{\text {lead }} \leq 83^{\circ} \mathrm{C}$; Fig. 2; Fig. 3 | - | - | 0.8 | A |
| $\mathrm{I}_{\text {TSM }}$ | non-repetitive peak onstate current | half sine wave; $\mathrm{T}_{\mathrm{j}(\text { (init })}=25^{\circ} \mathrm{C}$; $\mathrm{t}_{\mathrm{p}}=10 \mathrm{~ms}$; Fig. 4; Fig. 5 | - | - | 8 | A |
|  |  | half sine wave; $\mathrm{T}_{\mathrm{j}(\text { (init })}=25^{\circ} \mathrm{C}$; $\mathrm{t}_{\mathrm{p}}=8.3 \mathrm{~ms}$ | - | - | 9 | A |
| $\mathrm{T}_{\mathrm{j}}$ | junction temperature |  | - | - | 125 | ${ }^{\circ} \mathrm{C}$ |
| Static characteristics |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{GT}}$ | gate trigger current | $V_{D}=12 \mathrm{~V} ; \mathrm{I}_{\mathrm{T}}=10 \mathrm{~mA} ; \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \text {; }$ <br> Fig. 7 | - | 50 | 200 | $\mu \mathrm{A}$ |
| Dynamic characteristics |  |  |  |  |  |  |
| $d V_{D} / \mathrm{dt}$ | rate of rise of off-state voltage | $\mathrm{V}_{\mathrm{DM}}=134 \mathrm{~V} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C} ; \mathrm{R}_{\mathrm{GK}}=1 \mathrm{k} \Omega ;$ $\left(V_{D M}=67 \%\right.$ of $\left.V_{D R M}\right)$; exponential waveform; Fig. 12 | 500 | 800 | - | $\mathrm{V} / \mathrm{\mu s}$ |


| Symbol | Parameter | Conditions |  | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | $\mathrm{V}_{\mathrm{DM}}=134 \mathrm{~V} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C} ;\left(\mathrm{V}_{\mathrm{DM}}=67 \%\right.$ <br> of $\left.\mathrm{V}_{\mathrm{DRM}}\right) ;$ exponential waveform; gate <br> open circuit; Fig. 12 | - | 25 | - | $\mathrm{V} / \mathrm{\mu s}$ |  |

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| :---: | :---: | :---: | :---: | :---: |
| 1 | A | anode |  | A $\mathrm{H}^{\text {K }}$ |
| 2 | G | gate |  | G |
| 3 | K | cathode |  |  |

## 6. Ordering information

Table 3. Ordering information

| Type number | Package |  |  |
| :--- | :--- | :--- | :--- |
|  | Name | Description | Version |
| BT169B | TO-92 | plastic single-ended leaded (through hole) package; 3 leads | SOT54 |

## 7. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DRM }}$ | repetitive peak off-state voltage |  | - | 200 | V |
| $\mathrm{V}_{\text {RRM }}$ | repetitive peak reverse voltage |  | - | 200 | V |
| $\mathrm{I}_{\text {(AV) }}$ | average on-state current | half sine wave; $\mathrm{T}_{\text {lead }} \leq 83^{\circ} \mathrm{C}$; Fig. 1 | - | 0.5 | A |
| $\mathrm{I}_{\text {(RMS) }}$ | RMS on-state current | half sine wave; $\mathrm{T}_{\text {lead }} \leq 83^{\circ} \mathrm{C}$; Fig. 2; Fig. 3 | - | 0.8 | A |
| $\mathrm{I}_{\text {TSM }}$ | non-repetitive peak onstate current | half sine wave; $\mathrm{T}_{\mathrm{j}(\text { (init) }}=25^{\circ} \mathrm{C}$; $\mathrm{t}_{\mathrm{p}}=10 \mathrm{~ms}$; Fig. 4; Fig. 5 | - | 8 | A |
|  |  | half sine wave; $\mathrm{T}_{\mathrm{j} \text { (init) }}=25^{\circ} \mathrm{C} ; \mathrm{t}_{\mathrm{p}}=8.3 \mathrm{~ms}$ | - | 9 | A |
| $\mathrm{I}^{2} \mathrm{t}$ | $1^{2} t$ for fusing | $\mathrm{t}_{\mathrm{p}}=10 \mathrm{~ms} ; \mathrm{SIN}$ | - | 0.32 | $A^{2} \mathrm{~s}$ |
| $\mathrm{dl}_{\mathrm{T}} / \mathrm{dt}$ | rate of rise of on-state current | $\mathrm{I}_{\mathrm{T}}=2 \mathrm{~A} ; \mathrm{I}_{\mathrm{G}}=10 \mathrm{~mA} ; \mathrm{dl}_{\mathrm{G}} / \mathrm{dt}=100 \mathrm{~mA} / \mu \mathrm{s}$ | - | 50 | A/ $/ \mathrm{s}$ |
| $\mathrm{I}_{\mathrm{GM}}$ | peak gate current |  | - | 1 | A |
| $\mathrm{V}_{\mathrm{RGM}}$ | peak reverse gate voltage |  | - | 5 | V |
| $\mathrm{P}_{\mathrm{GM}}$ | peak gate power |  | - | 2 | W |
| $\mathrm{P}_{\mathrm{G}(\mathrm{AV})}$ | average gate power | over any 20 ms period | - | 0.1 | W |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  | -40 | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{j}}$ | junction temperature |  | - | 125 | ${ }^{\circ} \mathrm{C}$ |



Fig. 1. Total power dissipation as a function of average on-state current; maximum values


Fig. 2. RMS on-state current as a function of surge duration for sinusoidal currents


Fig. 3. RMS on-state current as a function of lead temperature; maximum values


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values


Fig. 5. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

## 8. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions |  | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $R_{\text {th(j-lead) }}$ | thermal resistance <br> from junction to lead | Fig. 6 | - | - | 60 | K/W |  |
| $R_{\text {th(j-a) }}$ | thermal resistance <br> from junction to <br> ambient free air | printed circuit board mounted: lead <br> length $=4 \mathrm{~mm}$ |  | - | 150 | - | K/W |



Fig. 6. Transient thermal impedance from junction to lead as a function of pulse width

## 9. Characteristics

Table 6. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Static characteristics |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{GT}}$ | gate trigger current | $V_{D}=12 \mathrm{~V} ; \mathrm{I}_{\mathrm{T}}=10 \mathrm{~mA} ; \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} ;$ <br> Fig. 7 | - | 50 | 200 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{L}}$ | latching current | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=12 \mathrm{~V} ; \mathrm{I}_{\mathrm{G}}=0.5 \mathrm{~mA} ; \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} ; \\ & \mathrm{R}_{\mathrm{GK}(\text { ext })}=1 \mathrm{k} \Omega ; \text { Fig. } 8 \end{aligned}$ | - | 2 | 6 | mA |
| $\mathrm{I}_{\mathrm{H}}$ | holding current | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=12 \mathrm{~V} ; \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} ; \mathrm{R}_{\mathrm{GK}(\mathrm{ext})}=1 \mathrm{k} \Omega ; \\ & \text { Fig. } 9 \end{aligned}$ | - | 2 | 5 | mA |
| $\mathrm{V}_{\mathrm{T}}$ | on-state voltage | $\mathrm{I}_{\mathrm{T}}=1.2 \mathrm{~A} ; \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$; Fig. 10 | - | 1.25 | 1.7 | V |
| $V_{G T}$ | gate trigger voltage | $V_{D}=12 \mathrm{~V} ; \mathrm{I}_{\mathrm{T}}=10 \mathrm{~mA} ; \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \text {; }$ $\text { Fig. } 11$ | - | 0.5 | 0.8 | V |
|  |  | $\begin{aligned} & V_{D}=200 \mathrm{~V} ; \mathrm{I}_{\mathrm{T}}=10 \mathrm{~mA} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C} ; \\ & \text { Fig. } 11 \end{aligned}$ | 0.2 | 0.3 | - | V |
| $\mathrm{I}_{\mathrm{D}}$ | off-state current | $\mathrm{V}_{\mathrm{D}}=200 \mathrm{~V} ; \mathrm{R}_{\mathrm{GK}(\text { ext) }}=1 \mathrm{k} \Omega ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ | - | 0.05 | 0.1 | mA |
| $\mathrm{I}_{\mathrm{R}}$ | reverse current | $\mathrm{V}_{\mathrm{R}}=200 \mathrm{~V} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C} ; \mathrm{R}_{\mathrm{GK}(\text { ext })}=1 \mathrm{k} \Omega$ | - | 0.05 | 0.1 | mA |
| Dynamic characteristics |  |  |  |  |  |  |
| $\mathrm{dV} \mathrm{V}_{\mathrm{D}} / \mathrm{dt}$ | rate of rise of off-state voltage | $V_{D M}=134 \mathrm{~V} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C} ; \mathrm{R}_{\mathrm{GK}}=1 \mathrm{k} \Omega$; $\left(V_{D M}=67 \%\right.$ of $\left.V_{D R M}\right)$; exponential waveform; Fig. 12 | 500 | 800 | - | V/us |
|  |  | $V_{D M}=134 \mathrm{~V} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$; $\left(\mathrm{V}_{\mathrm{DM}}=67 \%\right.$ of $\mathrm{V}_{\mathrm{DRM}}$ ); exponential waveform; gate open circuit; Fig. 12 | - | 25 | - | V/us |
| $\mathrm{tg}_{\mathrm{gt}}$ | gate-controlled turn-on time | $\begin{aligned} & \mathrm{I}_{\mathrm{TM}}=2 \mathrm{~A} ; \mathrm{V}_{\mathrm{D}}=200 \mathrm{~V} ; \mathrm{I}_{\mathrm{G}}=10 \mathrm{~mA} ; \mathrm{dl}_{\mathrm{G}} / \\ & \mathrm{dt}=0.1 \mathrm{~A} / \mu \mathrm{s} ; \mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{aligned}$ | - | 2 | - | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{q}}$ | commutated turn-off time | $\begin{aligned} & \mathrm{V}_{\mathrm{DM}}=134 \mathrm{~V} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C} ; \mathrm{I}_{\mathrm{TM}}=1.6 \mathrm{~A} ; \\ & \mathrm{V}_{\mathrm{R}}=35 \mathrm{~V} ;\left(\mathrm{d} \mathrm{l}_{\mathrm{T}} / \mathrm{dt}\right)_{\mathrm{M}}=30 \mathrm{~A} / \mu \mathrm{s} ; \mathrm{d} \mathrm{~V}_{\mathrm{D}} / \\ & \mathrm{dt}=2 \mathrm{~V} / \mu \mathrm{s} ; \mathrm{R}_{\mathrm{GK}(\mathrm{ext})}=1 \mathrm{k} \Omega ;\left(\mathrm{V}_{\mathrm{DM}}=\right. \\ & \left.67 \% \text { of } \mathrm{V}_{\mathrm{DRM}}\right) \end{aligned}$ | - | 100 | - | $\mu \mathrm{s}$ |



Fig. 7. Normalized gate trigger current as a function of junction temperature

$\mathrm{R}_{\mathrm{GK}}=1 \mathrm{k} \Omega$
Fig. 9. Normalized holding current as a function of junction temperature


Fig. 8. Normalized latching current as a function of junction temperature

$\mathrm{V}_{\mathrm{o}}=1.067 \mathrm{~V} ; \mathrm{R}_{\mathrm{s}}=0.187 \Omega$
(1) $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$; typical values
(2) $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$; maximum values
(3) $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$; maximum values

Fig. 10. On-state current as a function of on-state voltage


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

(1) $R_{G K}=1 \mathrm{k} \Omega$
(2) gate open circuit

Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values
10. Package outline


Fig. 13. Package outline TO-92 (SOT54)

## 11. Legal information

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## 12. Contents

1. General description...................................................... 1
2. Features and benefits................................................. 1
3. Applications........................................................................... 1
4. Quick reference data.................................................... 1
5. Pinning information..................................................... 2
6. Ordering information.................................................... 2
7. Limiting values............................................................ 3
8. Thermal characteristics............................................... 6
9. Characteristics.............................................................. 7
10. Package outline........................................................ 10
11. Legal information.................................................... 11
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